Designation: E2859 - 11 (Reapproved 2017)

Standard Guide for Size Measurement of Nanoparticles Using Atomic Force Microscopy¹

This standard is issued under the fixed designation E2859; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ε) indicates an editorial change since the last revision or reapproval.

1. Scope

- 1.1 The purpose of this document is to provide guidance on the quantitative application of atomic force microscopy (AFM) to determine the size of nanoparticles² deposited in dry form on flat substrates using height (z-displacement) measurement. Unlike electron microscopy, which provides a two-dimensional projection or a two-dimensional image of a sample, AFM provides a three-dimensional surface profile. While the lateral dimensions are influenced by the shape of the probe, displacement measurements can provide the height of nanoparticles with a high degree of accuracy and precision. If the particles are assumed to be spherical, the height measurement corresponds to the diameter of the particle. In this guide, procedures are described for dispersing gold nanoparticles on various surfaces such that they are suitable for imaging and height measurement via intermittent contact mode AFM. Generic procedures for AFM calibration and operation to make such measurements are then discussed. Finally, procedures for data analysis and reporting are addressed. The nanoparticles used to exemplify these procedures are National Institute of Standards and Technology (NIST) reference materials containing citratestabilized negatively charged gold nanoparticles in an aqueous solution.
- 1.2 The values stated in SI units are to be regarded as standard. No other units of measurement are included in this standard.
- 1.3 This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.
- 1.4 This international standard was developed in accordance with internationally recognized principles on standard-

¹ This guide is under the jurisdiction of ASTM Committee E56 on Nanotech-

ization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.

2. Referenced Documents

2.1 ASTM Standards:³

E1617 Practice for Reporting Particle Size Characterization
Data

E2382 Guide to Scanner and Tip Related Artifacts in Scanning Tunneling Microscopy and Atomic Force Microscopy

E2456 Terminology Relating to Nanotechnology

E2530 Practice for Calibrating the Z-Magnification of an Atomic Force Microscope at Subnanometer Displacement Levels Using Si(111) Monatomic Steps (Withdrawn 2015)⁴

E2587 Practice for Use of Control Charts in Statistical Process Control

2.2 ISO Standards:⁵

ISO 18115–2 Surface Chemical Analysis—Vocabulary— Part 2: Terms Used in Scanning-Probe Microscopy

ISO/IEC Guide 98–3:2008 Uncertainty of Measurement— Part 3: Guide to the Expression of Uncertainty in Measurement (GUM:1995)

3. Terminology

- 3.1 Definitions:
- 3.1.1 For definitions pertaining to nanotechnology terms, refer to Terminology E2456.
- 3.1.2 For definitions pertaining to terms associated with scanning-probe microscopy, including AFM, refer to ISO 18115–2.

nology and is the direct responsibility of Subcommittee E56.02 on Physical and Chemical Characterization.

Current edition approved Aug. 1, 2017. Published August 2017. Originally

approved in 2011. Last previous edition approved in 2011 as E2859 – 11. DOI: 10.1520/E2859-11R17.

² Having two or three dimensions in the size scale from approximately 1 nm to

Having two or three dimensions in the size scale from approximately 1 nm to 100 nm as in accordance with Terminology E2456; this definition does not consider functionality, which may impact regulatory aspects of nanotechnology, but which are beyond the scope of this guide.

³ For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

⁴The last approved version of this historical standard is referenced on www.astm.org.

⁵ Available from International Organization for Standardization (ISO), ISO Central Secretariat, BIBC II, Chemin de Blandonnet 8, CP 401, 1214 Vernier, Geneva, Switzerland, http://www.iso.org.

- 3.2 Definitions of Terms Specific to This Standard:
- 3.2.1 *agglomerate, n—in nanotechnology*, an assembly of particles held together by relatively weak forces (for example, Van der Waals or capillary), that may break apart into smaller particles upon processing, for example.

 E2456
- 3.2.1.1 *Discussion*—Using imaging based techniques, such as AFM, it is generally difficult to differentiate between agglomerates formed during the deposition process (that is, artifacts) and agglomerates or aggregates that pre-exist in the test sample.
- 3.2.2 aggregate, n—in nanotechnology, a discrete assemblage of particles in which the various individual components are not easily broken apart, such as in the case of primary particles that are strongly bonded together (for example, fused, sintered, or metallically bonded particles).

 E2456
- 3.2.2.1 *Discussion*—Using imaging based techniques, such as AFM, it is generally difficult to differentiate between aggregates and agglomerates.
 - 3.3 Acronyms:
 - 3.3.1 AFM—atomic force microscopy
 - 3.3.2 APDMES—3-aminopropyldimethylethoxysilane
 - 3.3.3 DI—deionized
 - 3.3.4 HEPA—high efficiency particulate air
 - 3.3.5 NIST—National Institute of Standards and Technology
 - 3.3.6 PLL—poly-L-lysine
 - 3.3.7 *RM*—reference material

4. Summary of Practice

4.1 This guide outlines the procedures for sample preparation and the determination of nanoparticle size using atomic force microscopy (AFM). An AFM utilizes a cantilever with a sharp probe to scan a specimen surface. The cantilever beam is attached at one end to a piezoelectric displacement actuator controlled by the AFM. At the other end of the cantilever is the probe tip that interacts with the surface. At close proximity to the surface, the probe experiences a force (attractive or repulsive) due to surface interactions, which imposes a bending

moment on the cantilever. In response to this moment, the cantilever deflects, and this deflection is measured using a laser beam that is reflected from a mirrored surface on the back side of the cantilever onto a split photodiode. A schematic diagram of the system is shown in Fig. 1. The cantilever deflection is measured by the differential output (difference in responses of the upper and lower sections) of the split photodiode. The deflections are very small relative to the cantilever thickness and length. Thus, the probe displacement is linearly related to the deflection. The cantilever is typically silicon or silicon nitride with a tip radius of curvature on the order of nanometers. More detailed and comprehensive information on the AFM technique and its applications can be found in the published literature (1, 2).

4.2 Based on the nature of the probe-surface interaction (attractive or repulsive), an AFM can be selected to operate in various modes, namely contact mode, intermittent contact mode, or non-contact mode. In contact mode, the interaction between the tip and surface is repulsive, and the tip literally contacts the surface. At the opposite extreme, the tip interacts with the surface via long-range surface force interactions; this is called non-contact mode. In intermittent contact mode (also referred to as tapping mode), the cantilever is oscillated close to its resonance frequency perpendicular to the specimen surface, at separations closer to the sample than in non-contact mode. As the oscillating probe is brought into proximity with the surface, the probe-surface interactions vary from long range attraction to weak repulsion and, as a consequence, the amplitude (and phase) of the cantilever oscillation varies. During a typical imposed 100-nm amplitude oscillation, for a short duration of time, the tip extends into the repulsive region close to the surface, intermittently touching the surface and thereby reducing the amplitude. Intermittent contact mode has the advantage of being able to image soft surfaces or particles weakly adhered to a surface and is hence preferred for nanoparticle size measurements.

⁶ The boldface numbers in parentheses refer to a list of references at the end of this standard.

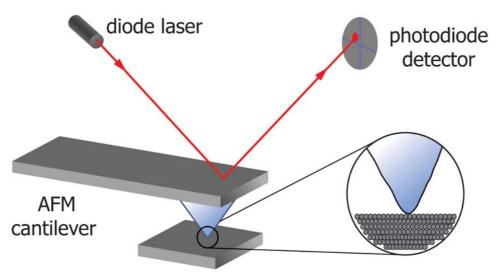


FIG. 1 Schematic Illustration of AFM Measurement Principle

4.3 A microscope feedback mechanism can be employed to maintain a user defined AFM set point amplitude, in the case of intermittent contact mode. When such feedback is operational, constant vibration amplitude can be maintained by displacing the built-in end of the cantilever up and down by means of the piezo-actuator.

Note 1—Operation of an AFM with feedback off enables the interactions to be measured and this is known as force spectroscopy.

This displacement directly corresponds to the height of the sample. A topographic image of the surface can be generated by rastering the probe over the specimen surface and recording the displacement of the piezo-actuator as a function of position. Although the lateral dimensions are influenced by the shape of the probe (see Guide E2382 for guidance on tip related artifacts), the height measurements can provide the height of nanoparticles deposited onto a substrate with a high degree of accuracy and precision. If the particles are assumed to be spherical, the height measurement corresponds to the diameter or "size" of the particle.

- 4.4 Procedures for dispersing nanoparticles on various surfaces such that they are suitable for imaging and height measurement via intermittent contact mode AFM are first described. The nanoparticles used to exemplify these procedures were National Institute of Standards and Technology (NIST) gold nanoparticle reference materials, RM 8011 (nominally 10 nm), RM 8012 (nominally 30 nm), and RM 8013 (nominally 60 nm), all of which contained citrate-stabilized negatively charged gold nanoparticles in an aqueous solution.
- 4.5 Generic procedures for AFM calibration and operation to perform size measurements in intermittent contact mode are discussed, and procedures for data analysis and reporting are outlined.

5. Significance and Use

5.1 As AFM measurement technology has matured and proliferated, the technique has been widely adopted by the nanotechnology research and development community to the extent that it is now considered an indispensible tool for visualizing and quantifying structures on the nanoscale. Whether used as a stand-alone method or to complement other dimensional measurement methods, AFM is now a firmly established component of the nanoparticle measurement tool box. International standards for AFM-based determination of nanoparticle size are nonexistent as of the drafting of this guide. Therefore, this standard aims to provide practical and metrological guidance for the application of AFM to measure the size of substrate-supported nanoparticles based on maximum displacement as the probe is rastered across the particle surface to create a line profile.

6. Reagents

- 6.1 Certain chemicals and materials may be necessary in order to perform one or more of the steps discussed in this guide, but the specific reagents used are at the discretion of the tester and may depend on which specific alternative procedures are chosen or relevant for a particular application.
 - 6.2 Adhesive tape, if needed to cleave mica substrates.

- 6.3 Atomically flat gold (111) on mica, if needed as a substrate material.
- 6.4 Colloidal gold, citrate-stabilized in aqueous solution, if needed to test or validate sample preparation and measurement procedures.
- 6.5 *Deionized water, filtered to 0.1 µm*, as needed for sample preparation or to rinse substrates.
- 6.6 Ethanol, reagent or chromatographic grade, as needed to rinse substrates.
- 6.7 HCl, concentrated (37 %), if needed to clean silicon (Si) substrates.
 - 6.8 H_2O_2 , 30 % solution, if needed to clean Si substrates.
- 6.9 *Inert compressed gas source* (for example, nitrogen, argon, or air), filtered to remove particles.
 - 6.10 Mica disc, if needed as a substrate material.
- 6.11 *Poly-l-lysine, solution* (0.1%), if needed for preparation of functionalized substrates.
- 6.12 Single crystal Si wafers, diced to appropriate size, if needed as a substrate material.

7. Apparatus

- 7.1 Atomic Force Microscope, capable of making z-displacement measurements at sub-nanoscale dimensions.
 - 7.2 Bath Ultrasonicator, as needed to clean substrates.
- 7.3 *Microcentrifuge* ("*Microfuge*"), as needed for sample preparation.
- 7.4 RF Plasma Cleaner with O_2 , as needed to clean Si substrates.

8. Procedure

8.1 Nanoparticle Deposition—For AFM measurements, nanoparticle samples must be deposited on flat surfaces. The roughness of the surface should be much less than the nominal size of the nanoparticles (preferably less than 5 %) in order to provide a consistent baseline for height measurements. Highquality mica, atomically flat gold (111) (deposited on mica), or single crystal silicon can all be used as substrates to minimize the effect of surface roughness on nanoparticle measurements. Example procedures are provided for depositing nanoparticles on these three substrates. The sample deposition procedures outlined below were developed for use with negatively charged citrate-stabilized gold nanoparticles suspended in an aqueous solution at a mass concentration nominally 50 µg/g (as exemplified by NIST RMs 8011, 8012, and 8013). The procedures should work with other nanoparticles that carry a negative surface charge or zeta potential, including, but not limited to, commercially available citrate-stabilized colloidal gold. As suggested below, these procedures can also be applied to positively charged or neutral nanoparticles with some modification. Each procedure may require optimization by the user in order to obtain satisfactory deposition density and to minimize artifacts such as agglomerate formation on the substrate or build-up of organic films resulting from additives that might be present in the solution phase.

Note 2—Substrate preparation and sample deposition should be conducted in a manner that minimizes the potential for contamination and artifacts. For instance, to the extent possible, these operations should be conducted in a HEPA filtered clean bench or work area. Similarly, prepared samples should be stored in a manner that maintains their integrity and precludes contamination.

8.1.1 *Mica Substrate*—Mica is a layered mineral that can be readily cleaved along alkali-rich basal planes to form clean, atomically flat surfaces extending over large areas. To prepare the substrate, a mica disc must be cleaved to produce a clean surface. Place the disc on a clean, lint-free cloth or directly on an AFM puck. Press a piece of adhesive tape against the surface of the disc and then smoothly remove the tape from the mica. The top layer of the mica should appear on the tape. Continue to cleave the mica until a full layer is removed and the exposed surface is visually smooth. Typically, this step needs to be repeated several times, and requires visual inspection of the cleaved surface.

8.1.1.1 After cleaving, the mica disc is ready to be activated so as to promote adhesion between the substrate and the gold nanoparticles. The NIST gold nanoparticle RMs are dispersed in solution and stabilized by adsorbed citrate ions that give the particles a negative charge. The mica substrate can be activated to have a positive charge that readily binds negatively charged particles to the surface. The substrate is activated using diluted 0.1 % poly-1-lysine (PLL) solution to provide a positively charged surface. To create the solution, dilute 0.1 % PLL solution 1:10 with filtered deionized (DI) water (for example, add 0.5 mL PLL to 4.5 mL DI water). Use clean glassware for dilution and coating. Store the diluted PLL solution in a refrigerator between 2°C and 8°C until needed. Fully immerse the mica disc in the diluted PLL solution for 30 min at room temperature. To minimize evaporation, cover the solution with a glass dish. After the time has elapsed, remove the mica from the solution and blow dry with a filtered inert gas stream (for example, air, nitrogen, argon).

8.1.1.2 After drying, apply $\approx 25\,\mu L$ of undiluted gold nanoparticle solution onto the PLL-modified mica substrate using a micropipette. The gold solution should spread evenly across the surface. Incubate at room temperature using the following schedule as a guide:

(1) 60 nm particles: 10 min.(2) 30 nm particles: 5 min.(3) 10 nm particles: 30 sec.

The incubation times are appropriate for 50 μ g/g colloidal gold suspensions, but can be varied to modify the particle density on the surface as required for particles of different size, composition or concentration; incubation times should be verified or optimized for each application. Rinse the substrate with filtered DI water and gently dry with a filtered inert gas stream. The sample is now ready to image.

8.1.2 Silicon Substrate—An electrostatic deposition procedure such as that described for negatively charged nanoparticles on mica can also be conducted using silicon as the substrate material. Dice a small sample (for example, 5 mm × 5 mm) from a silicon wafer or obtain pre-diced silicon substrates from a commercial source. Clean the sample using the following procedure: treat for 5 min in a wet oxygen

plasma cleaner,⁷ treat for 10 min in a clean glass beaker with acetone placed in a low intensity ultrasonic bath followed by 10 min sonication in a clean glass beaker with ethanol. Blow substrate dry with inert gas stream.

8.1.2.1 If a plasma cleaner is not available, the following alternative cleaning procedure can be used. Place silicon substrate in a solution containing a 6:1:1 volumetric ratio of DI water: concentrated HCl (37%): 30% H₂O₂ solution, and treat in a low intensity ultrasonic bath for 2 min to 10 min. Solution is a strong oxidizer and very acidic, and thus should be prepared and handled with due caution; always dilute acid into water. Follow treatment with a DI water rinse to remove any residual acid or peroxide.

Note 3—Pre-made cleaning solutions for silicon wafers are commercially available. Other cleaning procedures can be found in the literature. If using an alternative procedure, avoid treatments that tend to remove the native oxide layer (for example, basic solutions, such as those containing ammonium hydroxide). Be advised that some commonly used cleaning solutions for removing organics from glass surfaces (for example, acidified peroxide or piranha) are extremely aggressive and appropriate care should be taken if using such solutions.

8.1.2.2 The cleaned wafer supports a thin, native oxide layer. The substrate can then be treated to produce a positive surface using an amino-silane coupling agent, such as 3-aminopropyldimethylethoxysilane (APDMES). Place a drop of APDMES on the Si surface. Allow the APDMES to react with the underlying substrate for 2 h inside a sealed glass vial. Remove the excess APDMES by rinsing with ethanol followed by DI water.

8.1.2.3 After drying, apply $\approx 25\,\mu L$ of undiluted gold nanoparticle solution onto the APDMES-modified silicon substrate using a micropipette. The gold solution should spread evenly across the surface. Incubate at room temperature using the following schedule as a guide:

(1) 60 nm particles: 60 min.

(2) 30 nm particles: 30 min.

(3) 10 nm particles: 15 min.

The incubation times are approximate and should be verified or optimized for each application. To prevent evaporation, the substrate with gold solution droplet should be sealed inside a humidified chamber (for example, under an inverted glass beaker with DI water reservoir). Following incubation, rinse the sample first with ethanol, followed by DI water, and gently dry with a filtered inert gas stream prior to analysis.

8.1.3 *Gold Substrate*—An atomically flat gold (111) surface (deposited on mica) can be obtained commercially and used as a substrate for nanoparticle sizing. If necessary, clean the gold surface using ethanol and dry using a filtered stream of inert gas. It is recommended that ultrasonic cleaning not be used, as this may delaminate the gold layer from the underlying mica.

8.1.3.1 The gold substrate can be functionalized in a manner similar to that described for mica and silicon above, but using thiolated compounds that react chemically with the gold surface. For instance, an amino-thiol compound could be used to impart a positive surface charge to deposit negatively

 $^{^7}$ Plasma cleaners vary widely, and therefore specific settings and treatment times may vary and should be verified for each device. As a guide, typical settings would be RF power $\approx\!40\,W$ and pressure $\approx\!0.2\,$ mbar (20 Pa).

charged nanoparticles. In this case, one should follow the procedure described for APDMES above, but instead use an appropriately selected functionalized thiol compound (a variety of thiolated functional compounds are available commercially).

8.1.3.2 The nanoparticles can also be deposited on a native (that is, not functionalized) atomically flat gold surface using the drop-cast method, in which a drop of the test suspension is allowed to evaporate on the substrate surface. However, nanoparticles, including colloidal gold, are frequently stabilized with a surfactant or other capping agent, some of which may also be dissolved in the solution phase. As a result, AFM imaging may show a residual organic layer on the substrate and nanoparticle surface, which can potentially influence the accuracy of the nanoparticle measurements. If this is the case, the user may wish to adopt the following alternative preparation procedure for drop-casting, which utilizes a centrifuge to remove any excess surfactants or capping agents (for example, citrate ions) from the solution phase.

(1) Place an approximately 1 mL aliquot of gold suspension into a 1.5 mL microcentrifuge tube ("microtube") and use the rotation speed and spin times listed below as a guide. Remove and discard a portion of the supernatant from the microtube (according to the dilution ratio given below), then replace with DI water to obtain the proper dilution of the native suspension. No change in the stability of the suspension should be observed during this process. The following guidelines are appropriate for the gold nanoparticles using a typical bench-top microcentrifuge ("microfuge") capable of holding standard microfuge tubes (for example, up to 2 mL nominal volume); it may be necessary to vary these parameters in order to optimize deposition and minimize artifacts.

(a) 60 nm particles: dilution ratio 1:3; speed 5000 rpm (83.3 Hz) equivalent to 2040 g; time 5 min; volume of the suspension between 0.8 mL and 1 mL.

(b) 30 nm particles: dilution ratio 1:5; speed 8000 rpm (133.3 Hz) equivalent to 5220 g; time 6 min; volume of the suspension between 0.8 mL and 1 mL.

(c) 10 nm particles: dilution ratio 1:8; speed 14 000 rpm (233.3 Hz) equivalent to 16 000 g; time 20 min; volume of the suspension between 0.8 mL and 1 mL.

After the dilution and centrifuge process, a droplet ($\approx 0.05~\text{mL}$) of the suspension can be placed on the substrate using a micropipette and dried in air. To ensure removal of

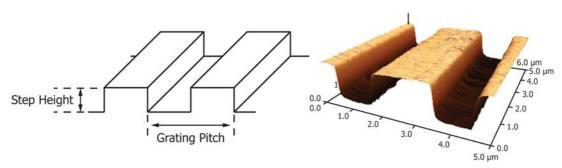
moisture, the deposited film can be additionally dried at an elevated temperature that is compatible with the nanoparticles and substrate (for example, $\approx 70^{\circ}$ C for gold nanoparticles on gold/mica substrate). The sample is now ready to image.

8.2 Optical Microscope Inspection—Inspect each sample using an optical microscope before AFM imaging to confirm that an appropriate level of deposition has occurred (that is, particles are well separated and not clumping) or to locate areas of the substrate where one can expect a reasonably good dispersion of the particles, or both. In the case of drop-cast test samples, the exterior of the dried droplet includes excess stabilizing agents (for example, citrate), while the interior is free of these agents with suitable particle distributions. Optical inspection may be hindered if the target particles do not absorb or scatter sufficient light, and the procedure is most useful for determining if over-deposition has occurred (that is, particle density is too high).

8.3 AFM Imaging and Size Measurement:

8.3.1 Accuracy (Height Calibration)—In order to obtain accurate measurements, the axial (z)-displacement of the piezoelectric stage needs to be calibrated using available traceable standards. In Fig. 2, we show a schematic diagram and AFM image of a calibration grating, which consists of a one-dimensional array of rectangular SiO₂ steps on a Si wafer. For this particular grating, the step height was certified to be 19.5 nm \pm 0.8 nm. After choosing a suitable grating (the step height of the grating should be similar to the characteristic height of the nanoparticles), measure the calibration grating in at least three locations using a sharp AFM tip and compare the average measured value to the certified step height. If the values are markedly different (for example, exceeds the uncertainty associated with the certified artifact), consult the AFM manufacturer on how to re-calibrate the z-displacement of the piezoelectric stage. Additionally, one may consult Practice E2530 regarding the calibration of z-scale using a Si(111) monatomic step artifact for nanometer and sub-nanometer displacements.

8.3.2 *Imaging Mode*—Nanoparticles are fixed to the substrate via weak physical forces (for example, electrostatic and van der Waals forces). As a result, intermittent contact mode is a suitable imaging mode in which the cantilever is driven to oscillate up and down near its resonance frequency by a small piezoelectric element mounted in the AFM tip holder. The



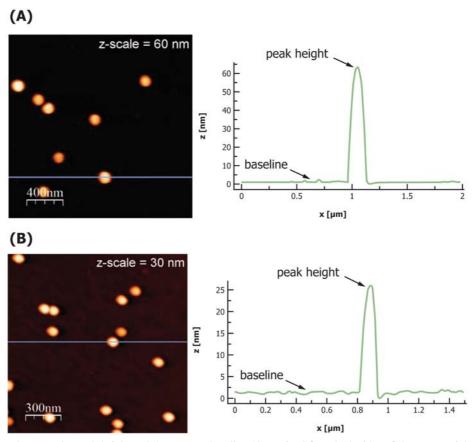
Note 1—For this particular grating, the step height was certified to be 19.5 nm \pm 0.8 nm.

FIG. 2 Schematic Diagram and AFM Image of a Calibration Grating Consisting of an Array of Rectangular SiO₂ Steps on a Si Wafer

amplitude of this oscillation is greater than 10 nm, typically from 100 nm to 200 nm.

- 8.3.3 Cantilevers—Probes consist of a cantilever integrated with a sharp tip on the end. The properties and dimensions of the cantilever and sharp tip play an important role in determining the sensitivity and resolution of the AFM. Several key features that should be considered when choosing an AFM cantilever are listed and discussed below:
- 8.3.3.1 *Tip Radius and Geometry*—A topographic AFM image is actually a convolution of the tip and sample geometry. While this does not affect height measurements, it does affect the overall representation of surface features. To minimize the convolution, it is best to use tips with radii <10 nm.
- 8.3.3.2 Cantilever Stiffness—Stable cantilever oscillations are required to successfully image a surface in intermittent contact mode, and are only possible when the cantilever has enough energy to overcome adhesive forces (for example, those arising from capillary menisci, van der Waals, and electrostatic forces) between the tip and sample. To overcome these forces, cantilevers with stiffness ≈40 N m⁻¹ are recommended.
- 8.3.3.3 Cantilever Tilt—In most AFM instruments, the cantilever itself is tilted by approximately 10° to 20° relative to the surface. This is to ensure that the tip makes contact with the sample before any other component, such as the nearby sides of the cantilever chip. While this does not affect height measurements, it does result in an asymmetric representation of the features. In cases where this may be a problem, some cantilever manufacturers offer "on scan angle" symmetric tips, which compensate for the cantilever tilt via the tip geometry.
- 8.3.4 Scan Size—AFM images have a lateral (x, y) resolution and a vertical (z) resolution. The radius of curvature of the end of the tip will determine the highest lateral resolution obtainable with a specific tip. However, another factor that needs to be considered during image analysis is the number of data points, or pixels, present in an image in the x and y scan-direction. For example, in acquiring a 10 μ m \times 10 μ m 512 pixels, pixel with the $\approx 19.5\,\text{nm}$ (10 $\mu\text{m}/512$ pixels). In this case, it is not possible to resolve features smaller than 19.5 nm at a 10 µm scan size. Thus, it is important to consider the particle size when choosing the scan size. The scan parameters shown below can be used as starting points.
- (1) 60 nm particles: scan size 2.0 μ m × 2.0 μ m; scan rate 1 Hz (per scan line).
- (2) 30 nm particles: scan size 1.0 μ m \times 1.0 μ m; scan rate 1 Hz.
- (3) 10 nm particles: scan size 0.5 μ m \times 0.5 μ m; scan rate 1 Hz.
- 8.3.5 Acquiring Images—After completing the general setup for the AFM (for example, calibrating the z-displacement of the piezoelectric stage, choosing and mounting the appropriate cantilever, tuning the cantilever, etc.), the instrument is now ready to begin the nanoparticle measurement process. At first, use a large scan size to identify a region with a homogeneous nanoparticle distribution. Once a suitable region has been identified, start collecting the nanoparticle images, using the scan parameters above as a starting point. Adjust the

- oscillation amplitude feedback gains (proportional and integral) to ensure that the forward and backward line scans (profiles) look identical. Store the images on the computer with incremental filenames for post-imaging analysis. If there is a sudden degradation in the image quality or the observed nanoparticle shape during the acquisition process, it is often advisable to replace the AFM cantilever, as it may have been damaged due to repeated contact with the substrate or altered by a nanoparticle on the tip.
- 8.4 *Image Analysis*—After images are captured during realtime operation, they can be viewed, modified, and analyzed offline using the software supplied by the AFM manufacturer. Some of the more useful data visualization and processing features for nanoparticle measurements will be discussed here.
- 8.4.1 Flatten and Plane-Fit Images—Usually, the first step in AFM image processing is a line-wise flatten or an image plane-fit to remove artifacts of the image acquisition process. For instance, samples are not always mounted perfectly perpendicular to the AFM tip, resulting in some tilt that is not actually present on the sample surface. Other artifacts include thermal drift and non-linearity in the scanner. The flatten and plane-fit techniques will correct these non-idealities by subtracting them from the data. First order (linear) corrections are normally sufficient to remove any artifacts of consequence. Higher order corrections should be avoided.
- 8.4.1.1 In the presence of nanoparticles, the flatten and plane-fit procedures are more difficult. The software attempts to fit a polynomial to both the substrate and the nanoparticles, instead of just fitting to the substrate. To "eliminate" certain features during this process, most AFM software packages include an "exclude points" function. Basically, this function can be used to exclude all selected points (for example, those within the boundaries of the nanoparticle) during the flatten and plane-fit processes, effectively ignoring the nanoparticles while adjusting the underlying substrate.
- 8.4.2 Cross-Sectional Line Profiles—Another common feature included in most commercial AFM software packages is the cross-section tool. A cross-sectional line can be drawn across any part of the image, and the vertical profile along that line is displayed. The cursors can be moved to make horizontal, vertical, and angular measurements. By making several cross-sectional line profiles across a nanoparticle, it is not only possible to calculate the particle height, but also to determine if the particle is isolated and sitting on a flat region (for example, not on a step edge).
- 8.4.3 Height Measurement Procedure—Draw a fixed, moving, or averaged cross-section through each particle as shown in Fig. 3. Use the cursors to find both the average value for the baseline (on both sides of the nanoparticle) and the peak height. If the flatten and plane-fit procedures were done properly (that is, the nanoparticles were excluded from the process), the baseline should be relatively flat over the line scan. Subtract the average baseline height from the peak height to find the nanoparticle height.
- 8.4.3.1 To ensure representative and unbiased sampling during AFM analysis of the mean particle size and size distribution, appropriate methodology should be applied to estimate the number of particles that must be counted to obtain



Note 1—The difference between the peak height and the average baseline (determined from both sides of the nanoparticle) is the particle height.

FIG. 3 AFM Images and Cross-Sections for Nominally 60 nm (A) and 30 nm (B) Gold Nanoparticles

the desired confidence level with respect to reported values. As a general guideline, it is recommended to count at least 100 nanoparticles; it is also prudent to obtain images from different locations on the substrate in order to avoid possible bias resulting from a single location. Further guidance on representative sampling can be found in the literature (3, 4).

8.4.3.2 Large agglomerates, as well as obvious extraneous particles, should be excluded from averaging, since it is difficult, and often impossible, to differentiate between artifacts and "real" pre-existing agglomerates or aggregates based on AFM image analysis.

8.4.4 Automated Batch-Mode Particle Analysis— Commercial AFM software packages typically offer an automated particle analysis function. The software can measure the height of particles based on the height of pixel data by using the threshold method and plot a histogram distribution. Prior to performing batch-mode measurements, the above mentioned flatten and plane-fit procedures must be applied to ensure a flat substrate. By adjusting the height threshold, the particles above this threshold can be included for analysis, while the particles below this threshold will be excluded. After selecting a group of particles, the distance between the maximum height of pixel data from individual particles and substrate can be automatically measured, and the height mean value and standard deviation of particles can be calculated. This batch-mode height analysis allows researchers to carry out the analysis of large numbers of particles during a short period of time and with minimal effort, but should be checked against manual measurements to ensure quality of results.

8.4.5 Control Samples—Which ever substrate is used for nanoparticle deposition, a control sample without the test particles should be prepared and imaged under equivalent conditions in order to ensure that artifacts or contaminants, which could be misconstrued as the target nanoparticles, are not introduced by the treatment process or inherent to the substrate material itself.

9. Report

9.1 Refer to Practice E1617 for general recommendations relating to the reporting of particle size data.

9.2 Reporting Particle Size Data Obtained from AFM Height Profiles—Calculate the mean and the expanded uncertainty for the particle height distributions according to the following procedure, which follows ISO/IEC Guide 98–3:2008 (5). The average, or arithmetic mean, particle height \bar{x} is given by:

$$\bar{X} = \frac{1}{n} \sum_{i=1}^{i=n} X_i \tag{1}$$

where n is the number of observations (that is, number of independent particle measurements) and X_i is the height of each particle. If an equivalent spherical diameter model is assumed to report height displacement data, then \overline{X} becomes equivalent

to $\overline{D}_{1,0}$, the arithmetic mean diameter as defined in Practice E2587. The most common method for describing the variation about the mean value is the standard deviation, or, more simply, the square root of the variance:

$$u_X = \sqrt{\frac{1}{n-1} \sum_{i=1}^{i=n} (X_i - \bar{X})^2}$$
 (2)

However, the uncertainty in determining \bar{X} is not defined by the standard deviation u_X , but by the *experimental standard deviation of the mean*, $u_{\bar{X}}$. The quantity $u_{\bar{X}}$ is related to the standard deviation via the relationship $u_{\bar{X}} = u_X / \sqrt{n}$, which yields:

$$u_{\bar{X}} = \sqrt{\frac{1}{n(n-1)} \sum_{i=1}^{i=n} (X_i - \bar{X})^2}$$
 (3)

Note 4—The quantity $u_{\bar{x}}$ as defined here is identified by the symbol $s(q_k)$ in ISO/IEC Guide 98–3:2008, and is sometimes referred to as the standard error of the mean.

It is important to consider not just the uncertainty associated with the mean particle height measurement, but other potential sources of experimental uncertainty as well. In particular, it is necessary to include the uncertainty associated with the step height grating used to calibrate the AFM. In the example case, the calibration grating had a mean height (G) of 19.5 nm, with a standard uncertainty (u_G) of 0.35 nm (not to be confused with the expanded uncertainty of 0.8 nm). The combined standard uncertainty (u_c) is obtained by combining the individual uncertainty contributions, $u_{\bar{x}}$ and u_G , using the following expression:

$$u_c = \sqrt{u_X^{-2} + u_G^{-2}} \tag{4}$$

The corresponding effective degrees of freedom $v_{\it eff}$ is obtained from the Welch–Satterthwaite equation:

$$\frac{u_c^4}{v_{eff}} = \frac{u_{\bar{X}}^4}{v_{\bar{X}}} + \frac{u_G^4}{v_G}$$
 (5)

where $v_{\bar{x}}$ and v_G are the degrees of freedom for the height measurements (=n-1) and the calibration grating measurements (reported on the corresponding certificate), respectively. The *expanded* uncertainty U_p , or the uncertainty that defines an interval having a level of confidence p, is then given by:

$$U_p = k_p u_c \tag{6}$$

where k_p is the coverage factor. The coverage factor is selected to achieve a desired level of confidence p using t-distribution tables (assuming v_{eff} degrees of freedom; see ISO/IEC Guide 98–3:2008). This yields a mean and expanded

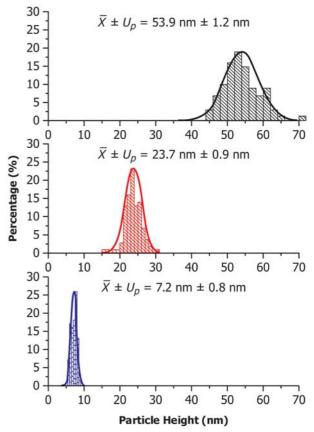


FIG. 4 Histograms for Nominally 60 nm (A), 30 nm (B), and 10 nm (C) Gold Nanoparticles

uncertainty for each data set that can be described by $\bar{X} \pm U_p$.

9.3 The height distributions for nominally 60 nm, 30 nm, and 10 nm gold nanoparticles (deposited on a mica substrate using the procedure outlined in 8.1.1) are shown in Fig. 4. For each data set, the mean and expanded uncertainties were calculated at a 95 % confidence level.

Note 5—The uncertainty in the mean (that is, the experimental standard deviation of the mean) is much less than the characteristic width of the histogram distribution for the gold reference materials used for this example; this is typical for such measurements.

10. Keywords

10.1 atomic force microscope; AFM; calibration; cantilever deflection; contact mode; functionalized substrate; gold nanoparticle; height displacement; intermittent mode; nanoparticle; nanoscale measurement; particle deposition; particle size; tapping mode



REFERENCES

- (1) Meyer, E., Hug, H. J., and Bennewitz, R., *Scanning Probe Microscopy: The Lab on a Tip*, Springer-Verlag: Berlin, 2004.
- (2) Morris, V. J., Kirby, A. R., and Gunning, A. P., Atomic Force Microscopy for Biologists, Imperial College Press: London, 1999.
- (3) Masuda, H., Iinoya, K., "Theoretical study of the scatter of experimental data due to particle size distribution," *Journal of Chemical Engineering—Japan*, Vol 4, No. 1, 1971, p. 60.
- (4) Allen, T., Particle Size Measurement—Volume 1: Powder Sampling and Particle Size Measurement, 5th Edition, Chapman & Hall, 1996.
- (5) Taylor, B. N., and Kuyatt, C. E., Guidelines for Evaluating and Expressing the Uncertainty of NIST Measurement Results, NIST Technical Note 1297, National Institute of Standards and Technology, U. S. Department of Commerce, 1994.

ASTM International takes no position respecting the validity of any patent rights asserted in connection with any item mentioned in this standard. Users of this standard are expressly advised that determination of the validity of any such patent rights, and the risk of infringement of such rights, are entirely their own responsibility.

This standard is subject to revision at any time by the responsible technical committee and must be reviewed every five years and if not revised, either reapproved or withdrawn. Your comments are invited either for revision of this standard or for additional standards and should be addressed to ASTM International Headquarters. Your comments will receive careful consideration at a meeting of the responsible technical committee, which you may attend. If you feel that your comments have not received a fair hearing you should make your views known to the ASTM Committee on Standards, at the address shown below.

This standard is copyrighted by ASTM International, 100 Barr Harbor Drive, PO Box C700, West Conshohocken, PA 19428-2959, United States. Individual reprints (single or multiple copies) of this standard may be obtained by contacting ASTM at the above address or at 610-832-9585 (phone), 610-832-9555 (fax), or service@astm.org (e-mail); or through the ASTM website (www.astm.org). Permission rights to photocopy the standard may also be secured from the Copyright Clearance Center, 222 Rosewood Drive, Danvers, MA 01923, Tel: (978) 646-2600; http://www.copyright.com/